

PATENT NUMBER and ISSUE DATE

U.S. UTILITY Patent Application

7	APPL NUM	FILING DATE	CL ACC	SUBCLASS	CALL	EXAMINER	
í	10002175	12/05/2001	228	l .	GAU 1725	Edmondson	
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	** FOREIGN APPLICATIONS VERIFIED: None - CRC						
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	Foreign priority claim 35 USC 119 condition		□ yes □ yes	29ho		ATTORNEY DOCKET NO	
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F	TITLE: Stacked chip connection using stand off stitch bonding						
L						U.S DEPT. OF COMM./PAT.& TM-PTO-436	L(Rev. 12-94)
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NOTICE OF ALLOWANCE MAILED ISSUE FEE			CLAIMS ALLOWED				
		Assistant Examiner	Total Claims Print Claim O.G		frit Claim for G		
			DRAWING				
Amount Due	Date Paid	Primary Examiner	Sheets Drwg.	Figs.Drwg.	Print Fig.		
TE	RMINAL	PREPARED FOR ISSUE	Application Examiner				
	DISCLAMER	WARNING: The information disclosed herein may be restricted. Unsuthorized disclosure may be prohibited by the United States Code Title 35, Sections 122, 181 and 368, Possession outside the U.S. Patent & Trademark Office is restricted to authorized employees and contractors only.					

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